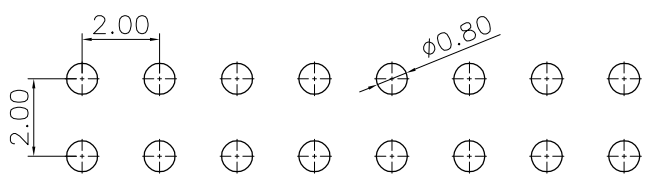
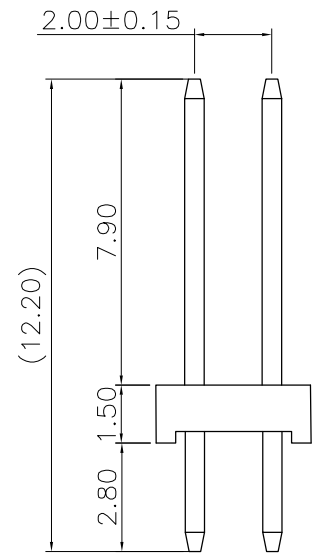
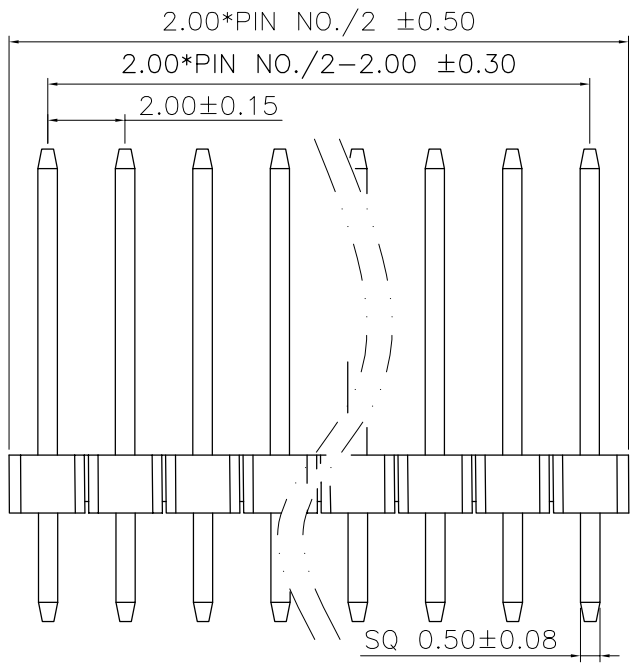
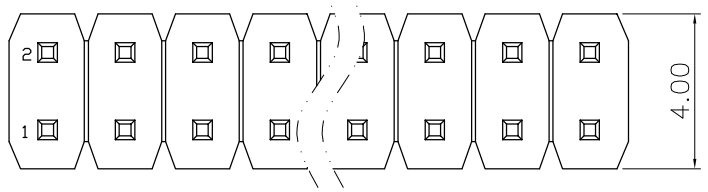


The product using material and processing must conform to the "WI-PZ-001" HSF technical standard control requirements



RECOMMENDED PCB LAYOUT
(GENERAL TOLERANCE: ±0.05)

NOTE:
 1.MATERIAL SPECIFICATION:
 1-1.HOUSING: THERMOPLASTIC HIGH TEMP,UL94V-0
 1-2.CONTACTS: BRASS
 2.PLATING SPECIFICATION:
 2-1.CONTACTS:
 TIN/GOLD FLASH PLATED OVER ALL.
 3.ELECTRICAL PERFORMANCE:
 3-1.CURRENT RATING: 2A AC/DC
 3-2.CONTACT RESISTANCE: 30 mΩ MAX
 3-3.INSULATION RESISTANCE: 1000MΩ Min
 3-4.DIELECTRIC WITHSTANDING : 300V
 4.ENVIRONMENTAL PERFORMANCE:
 4-1.OPERATING TEMPERATURE: -40°C~+105°C.
 5.PACKAGE SPEC: PE BAG
 6.P/N:

PH2005 15 M 0-2 XX 1 X X X 04
 SERIES NO: _____ HOUSING: 1-PA9T
 HEIGHT: _____ 15: 1.5mm
 MALE FEMALE: _____ M-MALE
 ANGLE: _____ 0-180°
 ROW NO: _____ 2-DOUBLE ROW
 PIN Q'PY: _____ 02~40
 COLOR: A-BLACK
 PLATING: A-ALL AU G/F
 TERMIPOINT: 1-DIP

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: PH200515M0-2XX1XXX04	DWG.NO: ENDE05	 WanLian Technology Co., Ltd	
AO	NEW RELEASE	22.05.09		LINEAR	ANGLES	APPROVED	Wang_jr	22.05.09				
			UNIT:mm	0.00±0.25	X'±3°	DESIGNER	Han_Gao	22.05.09	TITLE: Pitch 2.00mm 180° 双排 DIP 排针 H1.5	REV: A0		SHEET: 1/1
			SIZE: A4	0.000±0.10	X'X' ±2°	DRAWN	LanXuan_Hou	22.05.09				